

16V P-Channel Enhancement-Mode MOSFET

V_{DS} = -16V

R_{DSON}, V_{GS}@-4.5V, I_{DS}@-4.7A = 70 mΩ

R_{DSON}, V_{GS}@-2.5V, I_{DS}@-1.0A = 110 mΩ

Features

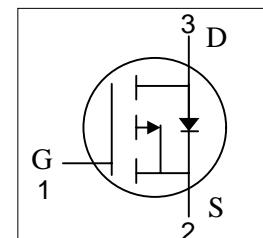
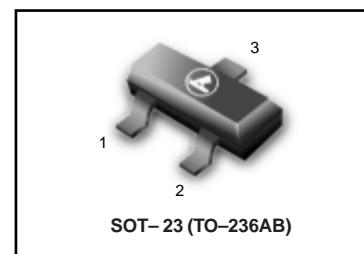
Advanced trench process technology

High Density Cell Design For Ultra Low On-Resistance

S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101

Qualified and PPAP Capable.

**LP2307LT1G
S-LP2307LT1G**



▼ Simple Drive Requirement

▼ Small Package Outline

▼ Surface Mount Device

Ordering Information

Device	Marking	Shipping
LP2307LT1G S-LP2307LT1G	P07	3000/Tape&Reel
LP2307LT3G S-LP2307LT3G	P07	10000/Tape&Reel

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	-16	V
V _{GS}	Gate-Source Voltage	±8	V
I _D @T _A =25°C	Continuous Drain Current ³	-4.7	A
I _D @T _A =70°C	Continuous Drain Current ³	-3.3	A
I _{DM}	Pulsed Drain Current ¹	-20	A
P _D @T _A =25°C	Total Power Dissipation	1.1	W
P _D @T _A =70°C	Total Power Dissipation	0.7	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Unit
R _{thj-a}	Thermal Resistance Junction-ambient ³	110	°C/W

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Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	-16	-	-	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance ²	$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-4.7\text{A}$	-	48	70	$\text{m}\Omega$
		$V_{\text{GS}}=-2.7\text{V}, I_{\text{D}}=-3.8\text{A}$	-	63	100	$\text{m}\Omega$
		$V_{\text{GS}}=-2.5\text{V}, I_{\text{D}}=-1.0\text{A}$	-	65	110	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$	-0.6	-0.85	-1.4	V
g_{fs}	Forward Transconductance	$V_{\text{DS}}=-10\text{V}, I_{\text{D}}=-4.7\text{A}$	-	8	-	S
I_{DSS}	Drain-Source Leakage Current ($T_j=25^\circ\text{C}$)	$V_{\text{DS}}=-16\text{V}, V_{\text{GS}}=0\text{V}$	-	-	-1	μA
I_{GSS}	Gate-Source Leakage	$V_{\text{GS}}=\pm 8\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
Q_g	Total Gate Charge ²	$I_{\text{D}}=-4.7\text{A}$	-	24	36	nC
Q_{gs}	Gate-Source Charge	$V_{\text{DS}}=-10\text{V}$	-	18	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge		-	2.7	-	nC
$t_{\text{d(on)}}$	Turn-on Delay Time ²	$V_{\text{DS}}=-10\text{V}$	-	22	35	ns
t_r	Rise Time	$I_{\text{D}}=-1\text{A}$	-	35	55	ns
$t_{\text{d(off)}}$	Turn-off Delay Time	$R_G=6\Omega, V_{\text{GS}}=-4.5\text{V}$	-	45	70	ns
t_f	Fall Time	$R_D=10\Omega$	-	25	40	ns
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$	-	985	1580	pF
C_{oss}	Output Capacitance	$V_{\text{DS}}=-15\text{V}$	-	180	-	pF
C_{rss}	Reverse Transfer Capacitance	$f=1.0\text{MHz}$	-	160	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
I_s	Max Diode Forward Current				-1.7	A
V_{SD}	Diode Forward Voltage	$I_s=-1.7\text{A}, V_{\text{GS}}=0\text{V}$			-1.2	V

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
- 3.Surface mounted on 1 in² copper pad of FR4 board ; $270^\circ\text{C}/\text{W}$ when mounted on min. copper pad.

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TYPICAL ELECTRICAL CHARACTERISTICS

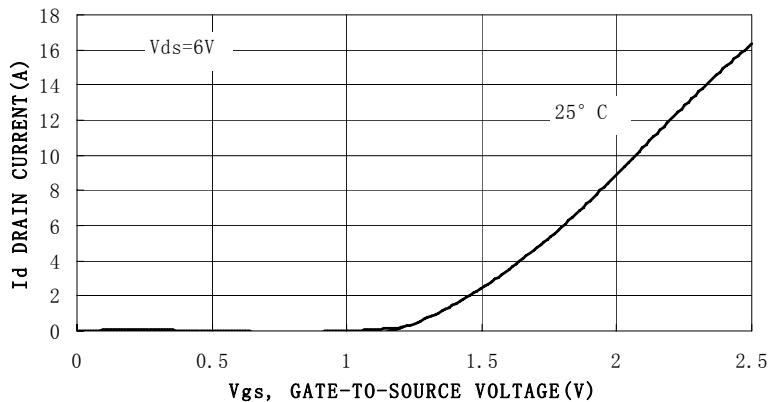


Figure 1. Transfer Characteristics

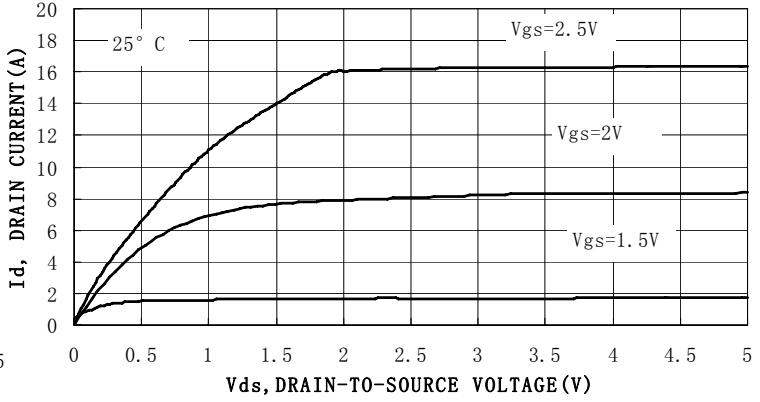


Figure 2. On-Region Characteristics

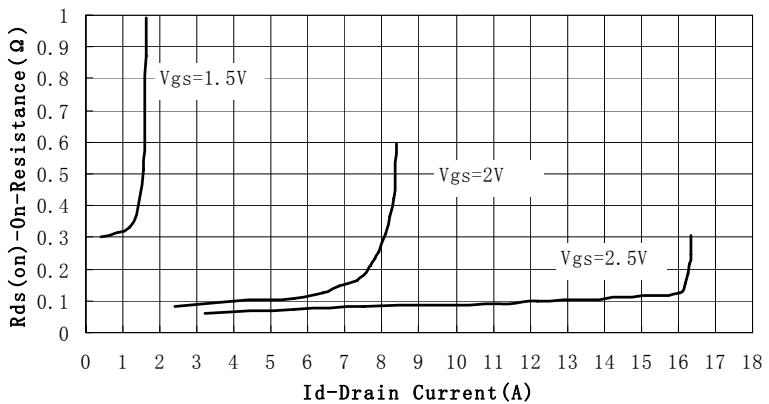


Figure 3. On-Resistance versus Drain Current

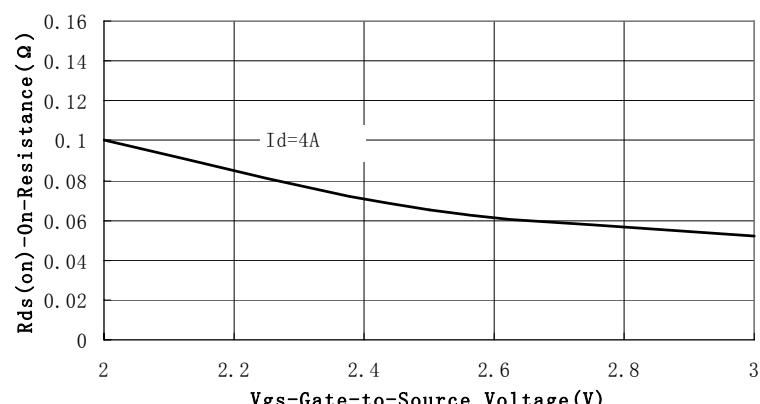
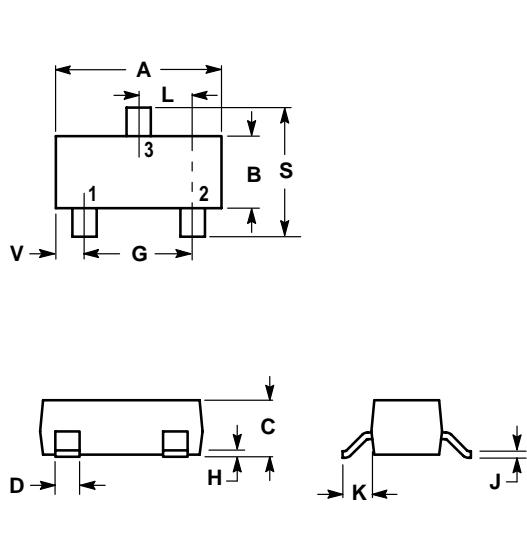
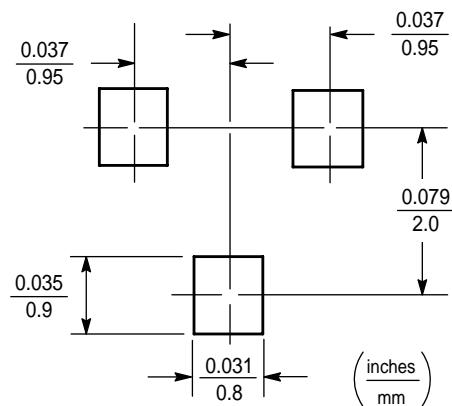


Figure 4. On-Resistance vs. Gate-to-Source Voltage

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SOT-23

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M,1982
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60



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